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LED SMD



Lead-Free Parts

LG-170H-IR-CT/T100

**DATA SHEET**

DOC. NO : QW0905-LG-170H-IR-CT/T100

REV. : A

DATE : 11 - May. - 2017



**Features:**

1. Package in 8.0mm carrier tape on 7" diameter reel.
2. Compatible with automatic placement equipment.
3. Compatible with reflow solder process.

**Descriptions:**

1. The LG-170H SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
2. Besides, lightweight makes them ideal for miniature applications. etc.

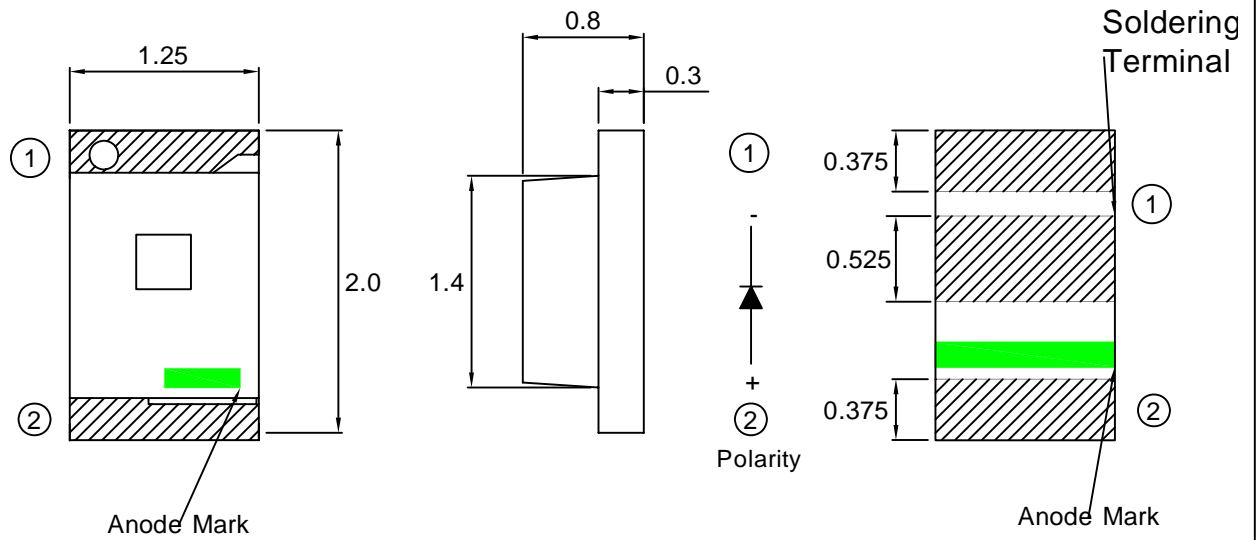
**Applications:**

1. Automotive : backlighting in dashboard and switch.
2. Telecommunication : indicator and backlighting in telephone and fax.
3. Flat backlight for LCD, switch and symbol
4. General use.

**Device Selection Guide:**

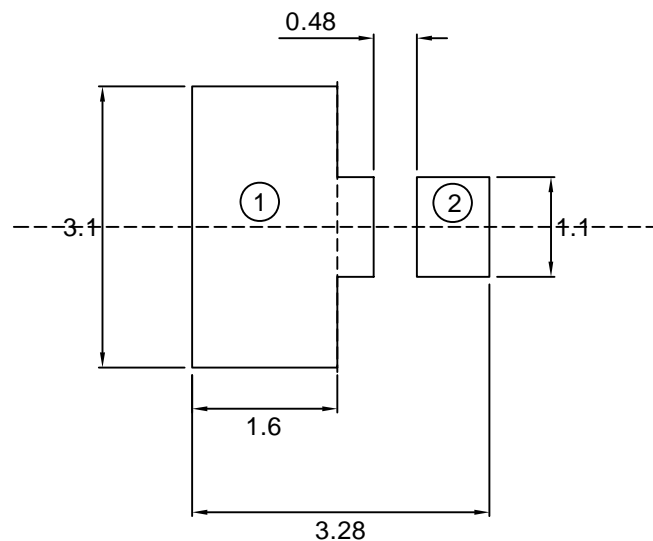
PART NO	MATERIAL	COLOR	
		Emitted	Lens
LG-170H-IR-CT/T100	GaAIAs	Infrared	Water Clear

**Package Dimensions**



Note : 1.All dimension are in millimeter tolerance is  $\pm 0.1\text{mm}$  unless otherwise noted.  
 2.Specifications are subject to change without notice.

**Recommended Soldering Pad Dimensions**



Note : The tolerances unless mentioned is  $\pm 0.1\text{mm}$ , Angle  $\pm 0.5$ . Unit=mm.

### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Ratings	UNIT
Power Dissipation	PD	220	mW
Peak Forward Current (1KHZ 1/10 duty)	IFP	150	mA
Forward Current	IF	100	mA
Reverse Voltage	Vr	5	V
Operating Temperature	Topr	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +100	°C

### Typical Electrical & Optical Characteristics (Ta=25°C)

Items	Symbol	Min.	Typ.	Max.	UNIT	CONDITION
Radiant Intensity	Po	1.8	4.6	----	mW/sr	IF=100mA
Peak Emission Wavelength	$\lambda_{peak}$	----	940	----	nm	IF=100mA
Spectral Line Half-Width	$\Delta \lambda$	----	50	----	nm	IF=100mA
Forward Voltage	V <sub>F</sub>	1.4	----	2.2	V	IF=100mA
Reverse Current	IR	----	----	100	μA	IF=100mA
Viewing Angle	2θ 1/2	----	140	----	deg	IF=100mA

Note : 1.The forward voltage data did not including  $\pm 0.1V$  testing tolerance.  
2. The Radiant Intensity data did not including  $\pm 15\%$  testing tolerance.

### Luminous Intensity Classification

BIN CODE	Po(mW/sr) at 100mA	
	Min.	Max.
M	1.8	2.4
N	2.4	3.2
P	3.2	4.2
Q	4.2	5.5

## Typical Electro-Optical Characteristics Curve

### IR CHIP

Fig.1 Forward Current vs. Forward Voltage

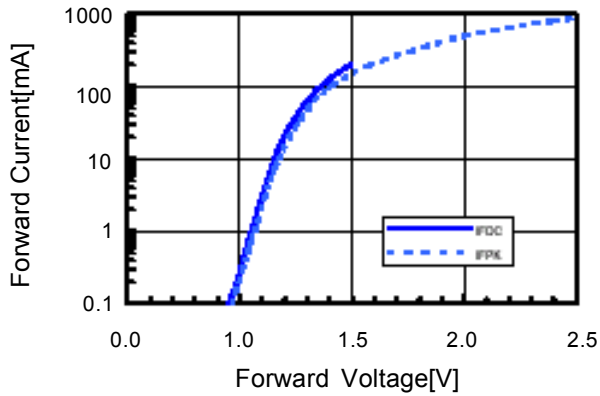


Fig.2 Relative Radiant Power vs. Wavelength

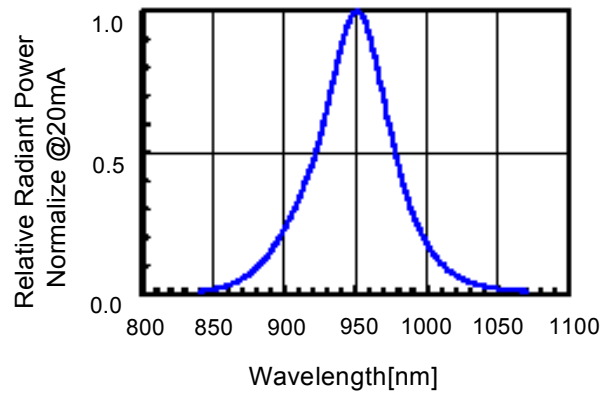


Fig.3 Relative Radiant Power vs. Forward DC Current

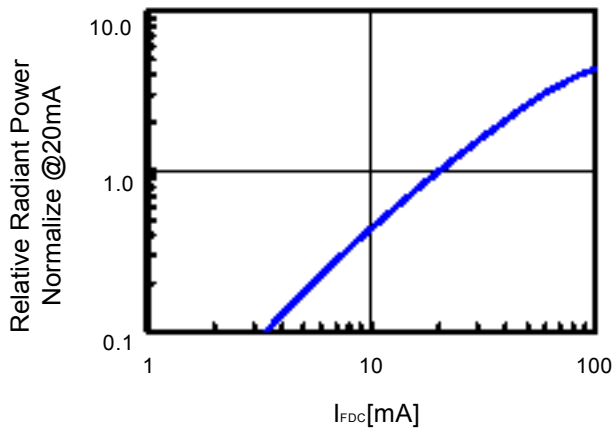


Fig.4 Relative Radiant Power vs. Forward Peak Current

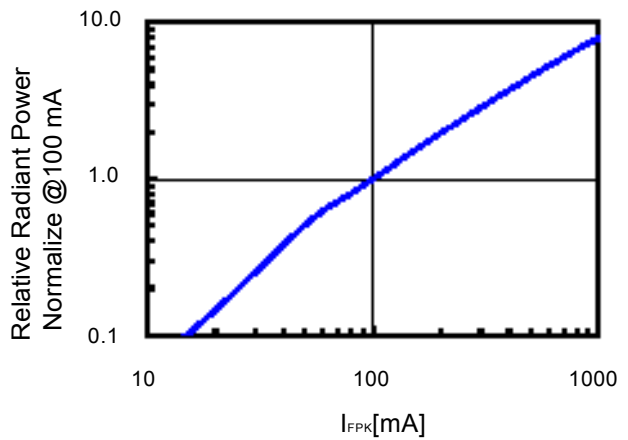


Fig.5 Forward DC Voltage vs. Temperature

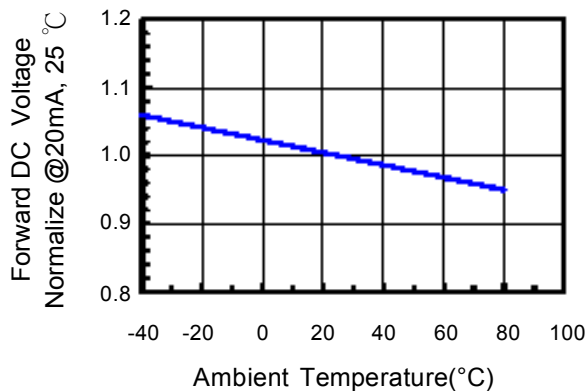
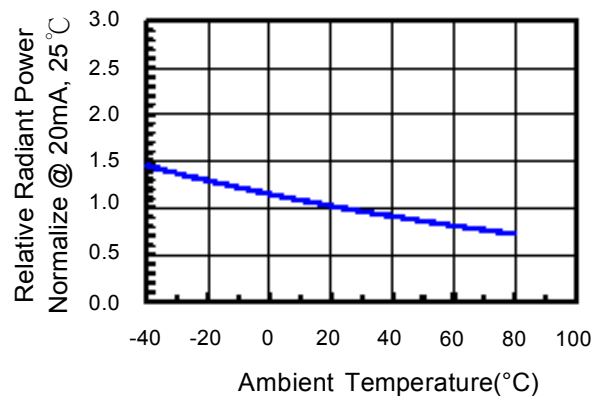
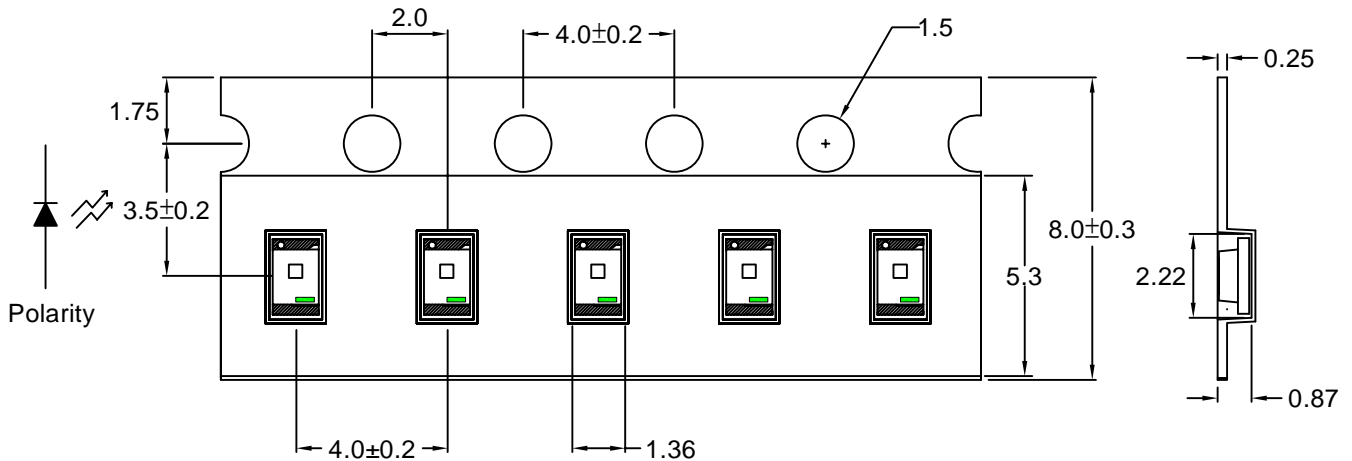


Fig.6 Relative Radiant Power vs. Temperature

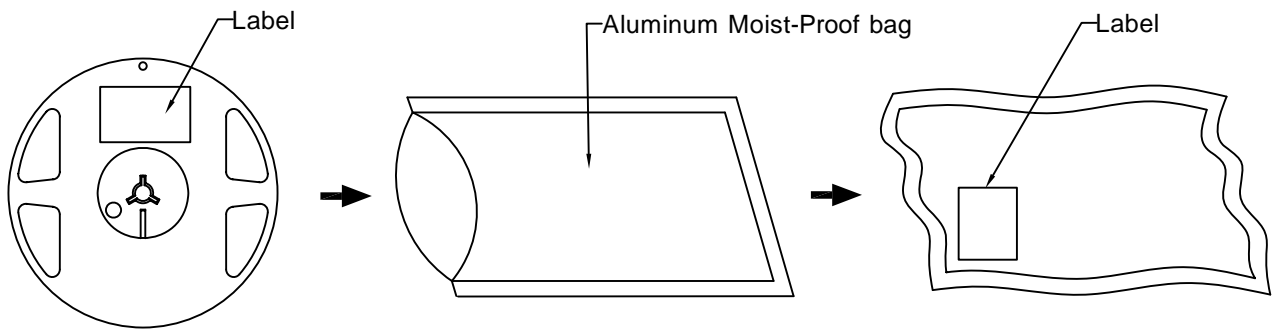


### Carrier Type Dimensions




Note : The tolerances unless mentioned is  $\pm 0.1$ mm, Angle  $\pm 0.5$ . Unit=mm.





### • Packing Specifications




Part No.	Description	Quantity/Reel
LG-170H-IR-CT/T100	8.0mm tape,7"reel	4000 devices

## Label Explanation

	LIGITEK ELECTRONICS CO., LTD.	
	PART :	LG-170H-IR-CT/T100
	LOT :	GS11690168
	QTY(PCS):	4000
	BIN/HUE :	M

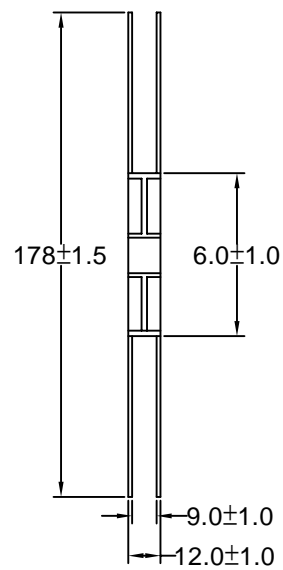
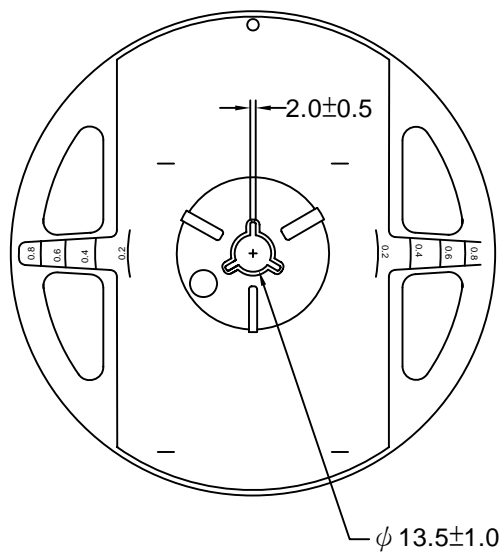

  
 VF:1.4-2.2

BIN : Luminous Intensity

HUE : Dominant Wavelength

VF : Forward Voltage

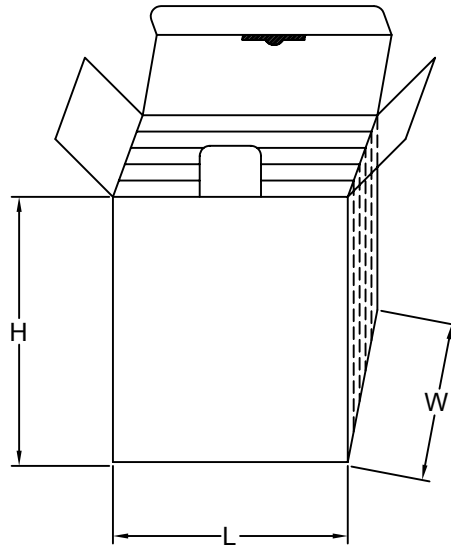
## Reel Dimensions



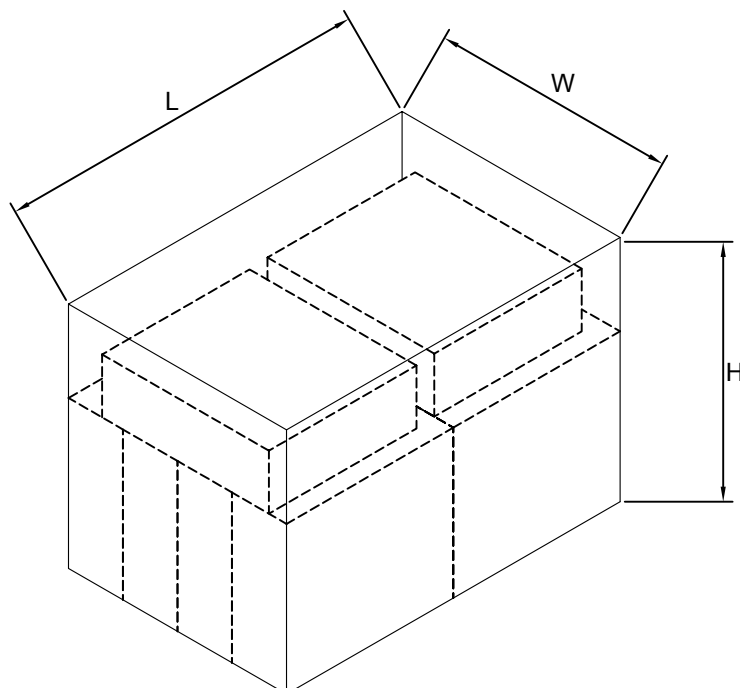


## Box Explanation

1. 5 BAG / INNER BOX
2. INNER BOX SIZE : L X W X H 23cm X 8.5cm x 26cm

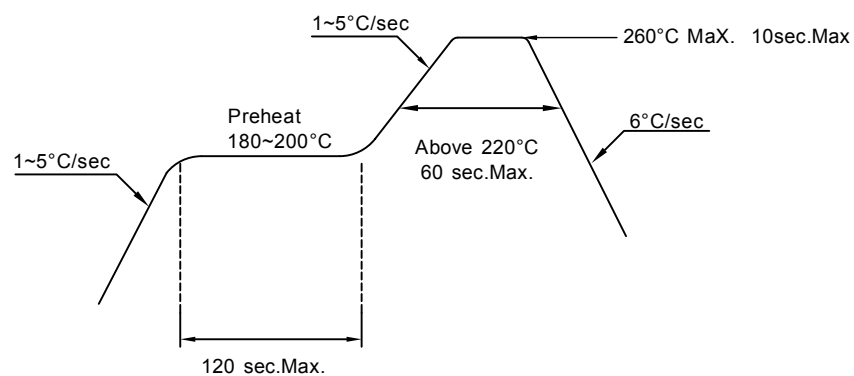


3. 10 INNER BOXES / CARTON
4. CARTON SIZE : L X W X H 58cm X 34cm x 35cm



**Recommended Soldering Conditions****1. Hand Solder**

Basic spec is  $\leq 280^{\circ}\text{C}$  3 sec one time only.

**2. PB-Free Reflow Solder****Note:**

- 1.Reflow soldering should not be done more than two times.
- 2.When soldering,do not put stress on the LEDs during heating.
- 3.After soldering,do not warp the circuit board.

**Precautions For Use:****Storage time:**

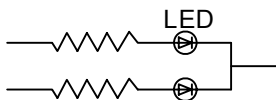
1. Calculated shelf life before opening is 12 months at  $< 30^{\circ}\text{C}$  and  $< 90\%$  relative humidity (RH)
2. After bag is opened, devices which will be subjected to reflow soldering or other high temperature processes must be
  - a) Assembled within 168 hours in an environment of  $\leq 30^{\circ}\text{C} / 60\%$  RH, or
  - b) Stored at ambient of 10% RH or less
3. Devices are required baking before assembly if:
  - a) Humidity Indicator Card reads  $>10\%$  (for level 2a -5a) or  $>60\%$  (for level 2) at ambient temperature  $23 \pm 5^{\circ}\text{C}$
  - b) 2.a) or 2.b) doesn't meet
4. If baking is required, devices should be baked for  $>72$  hours at  $60 \pm 5^{\circ}\text{C} / 5\%$  RH. Performing baking only once, and using the baked devices within 72 hours.

**Drive Method:**

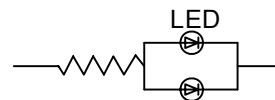
LED is a current operated device, and therefore, requires some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor placed in series with the LED.

Consider worst case voltage variations than could occur across the current limiting resistor. The forward current should not be allowed to change by more than 40% of its desired value.

Circuit model A



Circuit model B



(A) Recommended circuit.

(B) The difference of brightness between LED could be found due to the VF-IF characteristics of LED.

**Cleaning:**

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

**ESD(Electrostatic Discharge):**

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handling these LED. All devices, equipment and machinery must be properly grounded.

Reliability Test:

Classification	Test Item	Test Condition	Sample Size
Endurance Test	Operating Life Test	1.Ta=25°C 2.If=100mA 3.t=1000 hrs (-24hrs,+72hrs)	22
	High Temperature Storage Test	1.Ta=100°C±5°C 2.t=1000 hrs (-24hrs,+72hrs)	22
	Low Temperature Storage Test	1.Ta=-40°C±5°C 2.t=1000 hrs (-24hrs,+72hrs)	22
	High Temperature High Humidity Storage Test	1.Ta=85°C 2.RH=85% 3.t=1000hrs(-24hrs,+72hrs)	22
Environmental Test	Thermal Shock Test	1.Ta=100°C±5°C ~ -40°C±5°C 20min/ 10sec / 20min 2.total 100 cycles	22
	Temperature Cycling	1.100°C±5°C ~ -40°C±5°C 30mins / 5mins / 30mins 2.100 Cyeles	22
	IR Reflow	1.T=260°C Max. 10sec.Max. 2. 6 Min	22